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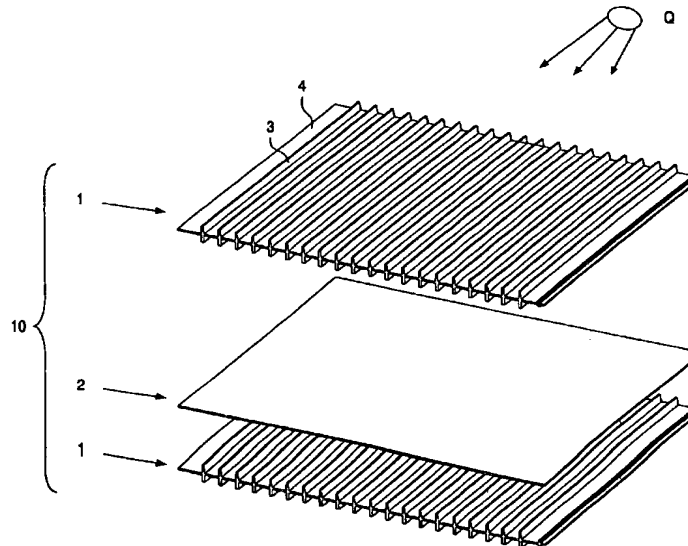
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(54) Title: GRID FOR THE ABSORPTION OF X-RAYS



(57) Abstract: The invention relates to an anti-scatter grid for the absorption of X-rays, wherein the wall elements (3) of the grid consist of a thermoplastic (7) with heavy metal particles (8) embedded therein. By using such a mixture, it is possible to produce the wall elements by injection molding, whereby even very finely and complicatedly shaped, in particular two-dimensional, grids may be produced in cost-effective manner.

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